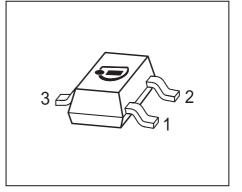


BF775

NPN Silicon RF Transistor

- Especially suitable for TV-Sat and UHF tuners
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BF775	LOs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	15	V	
Collector-emitter voltage	V _{CES}	20		
Collector-base voltage	V _{CBO}	20		
Emitter-base voltage	V _{EBO}	2.5		
Collector current	I _C	45	mA	
Base current	/ _B	4		
Total power dissipation ²⁾	P _{tot}	280	mW	
$T_{S} \leq 48^{\circ}C$				
Junction temperature	Ti	150	°C	
Ambient temperature	T _A	-65 150		
Storage temperature	T _{stq}	-65 150		

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ 365	K/W

¹Pb-containing package may be available upon special request

 $^{2}T_{S}$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.]
DC Characteristics					•
Collector-emitter breakdown voltage	V _{(BR)CEO}	15	-	-	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					
Collector-emitter cutoff current	I _{CES}	-	-	10	μA
$V_{\rm CE} = 20 \text{ V}, V_{\rm BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	100	μA
$V_{\rm EB} = 2.5 \text{ V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

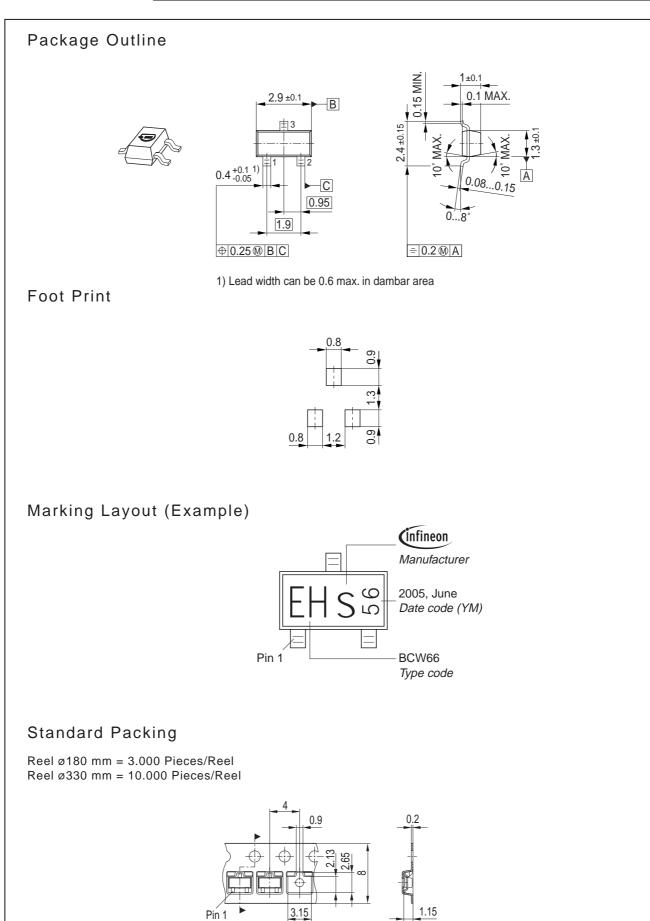


Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1			
Transition frequency	f _T	3.5	5	-	GHz
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.39	0.55	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.23	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	0.64	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,					
collector grounded					
Noise figure	F				dB
$I_{\rm C} = 2 \text{ mA}, V_{\rm CE} = 6 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$					
<i>f</i> = 900 MHz		-	1.4	-	
<i>f</i> = 1.8 GHz		-	2	-	
Power gain, maximum available ¹⁾	G _{ma}				1
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}, f = 900 \rm MHz$		-	16	-	
f = 1.8 GHz		-	10.5	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C} = 15 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm L} = 50\Omega,$					
f = 900 MHz		-	13	-	
<i>f</i> = 1.8 GHz		-	7.5	-	

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}\mathrm{G}_{\mathrm{ma}} = |\mathrm{S}_{21}/\mathrm{S}_{12}| \; (\mathrm{k}\text{-}(\mathrm{k}^{2}\text{-}1)^{1/2})$







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